

2010 FOR PROFIT CORPORATION ANNUAL REPORT

DOCUMENT# F97000001810

FILED
Feb 17, 2010
Secretary of State

Entity Name: MICRON SEMICONDUCTOR PRODUCTS, INC.

Current Principal Place of Business:

8000 S. FEDERAL WAY
BOISE, ID 837169632 US

New Principal Place of Business:

Current Mailing Address:

8000 S. FEDERAL WAY MS 507
BOISE, ID 837169632 US

New Mailing Address:

8000 S. FEDERAL WAY
BOISE, ID 837169632 US

FEI Number: 82-0493274

FEI Number Applied For ()

FEI Number Not Applicable ()

Certificate of Status Desired ()

Name and Address of Current Registered Agent:

CORPORATION SERVICE COMPANY
1201 HAYS STREET
TALLAHASSEE, FL 32301 US

Name and Address of New Registered Agent:

The above named entity submits this statement for the purpose of changing its registered office or registered agent, or both, in the State of Florida.

SIGNATURE:

Electronic Signature of Registered Agent

Date

Election Campaign Financing Trust Fund Contribution ().

OFFICERS AND DIRECTORS:

Title: P/D
Name: ADAMS, MARK W
Address: 8000 S FEDERAL WAY
City-St-Zip: BOISE, ID 837169632 US

Title: VP/T
Name: LAWS, THOMAS L JR.
Address: 8000 S. FEDERAL WAY
City-St-Zip: BOISE, ID 837169632 US

Title: VP
Name: BOKAN, MICHAEL W
Address: 8000 S FEDERAL WAY
City-St-Zip: BOISE, ID 837169632 US

Title: SEC
Name: SPANG, PAULA R
Address: 8000 S FEDERAL WAY
City-St-Zip: BOISE, ID 837169632 US

Title: ASEC
Name: JAN, REIMER R
Address: 8000 S FEDERAL WAY
City-St-Zip: BOISE, ID 837169632 US

Title: D
Name: LAWS, THOMAS L JR.
Address: 8000 S FEDERAL WAY
City-St-Zip: BOISE, ID 837169632 US

I hereby certify that the information indicated on this report or supplemental report is true and accurate and that my electronic signature shall have the same legal effect as if made under oath; that I am an officer or director of the corporation or the receiver or trustee empowered to execute this report as required by Chapter 607, Florida Statutes; and that my name appears above, or on an attachment with all other like empowered.

SIGNATURE: PAULA R. SPANG

SEC

02/17/2010

Electronic Signature of Signing Officer or Director

Date